Electronic Patent Application Fee Transmittal							
Application Number:	10557694						
Filing Date:	22-Nov-2005						
Title of Invention:	Resin for photoresist composition, photoresist composition and method for forming resist pattern						
First Named Inventor/Applicant Name:	Hideo Hada						
Filer:	Neil S. Bartfeld/Brittany Miles						
Attorney Docket Number:	SHIGA7.033APC						
Filed as Large Entity							
U.S. National Stage under 35 USC 371 Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							
Extension - 1 month with \$0 paid		1251	1	120	120		

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	810	810
	Tota	930		